

innodisk

Innodisk Corporate Investor Conference (Symbol: 5289)

Randy Chien, Chairman 2026.3.30

DISCLAIMER

This file and the financial information and forecast information are based on information obtained by the company from internal and external sources. The actual operating results and financial conditions of the company may differ from these predictive sets of information due to various uncontrollable factors.

The viewpoints in this file reflects the company's opinion on the future by the current date. If there are any changes or adjustment in the future, the company is not responsible for notifying the reader or updating the content.

AGENDA

- Company Profile and Overview
- Market Trend and Product Strategy
- AI in Action Global Campaign
- ESG Commitment
- Financial Information
- Q&A

COMPANY PROFILE & OVERVIEW

CORPORATE OVERVIEW

REVENUE

NT\$14.3B

(2025)

CAPITAL

NT\$960M

EPS

NT\$21.72

(2025)

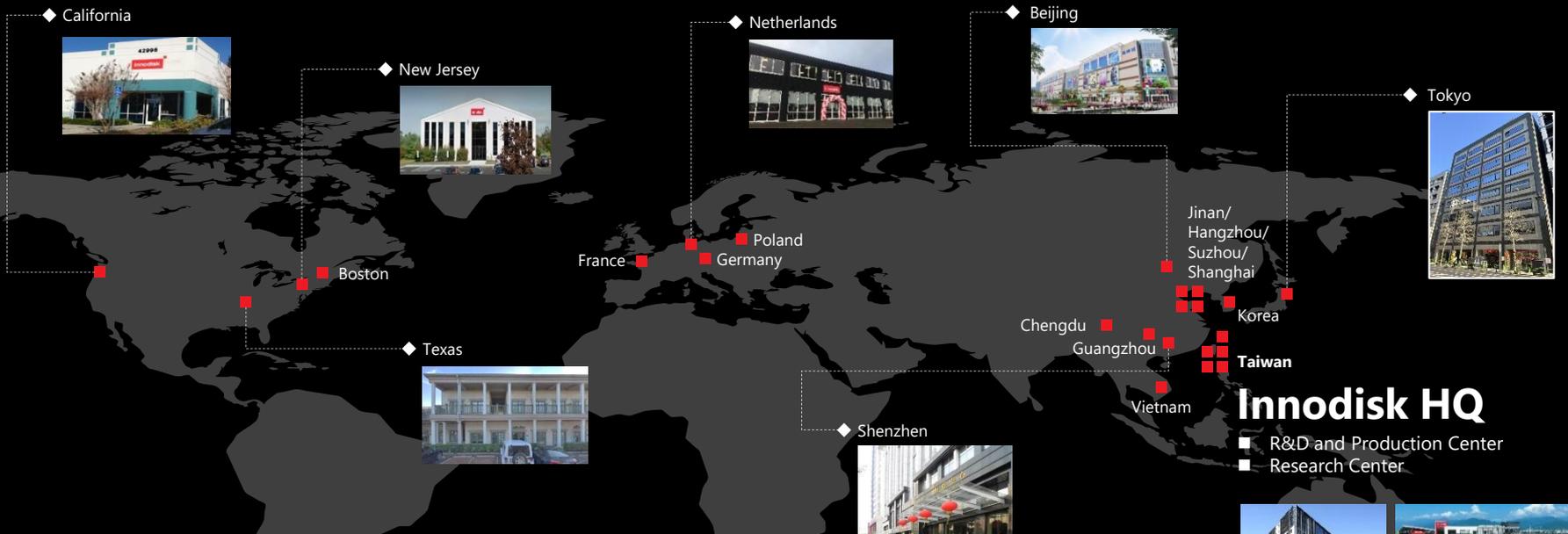
PATENTS

203(+8)

CUSTOMERS

4,000+

GLOBAL BUSINESS OPERATIONS



Locations

25

Employees

1,164

Taiwan: 1,019 / Overseas: 145



Lot Size
(Sq. Meter)

27,000

Floor Area:
1st building (Sq. Meter)

12,000

Floor Area:
2nd building (Sq. Meter)

15,000

Edge AI System and Solution
Edge AI Embedded Peripheral
Edge AI Camera Module

2026 Capacity
(SMT x 6)

1,080K

Maximum Capacity
(SMT x 8)

1,440K



YILAN R&D & MANUFACTURING CENTER

SPACE

Total :19,800 m²

17F 1,650 m² (Aetina)

16F 3,300 m² (R&D Center / Sports & Recreation Center)



7F 3,300 m² (Aetina 660 m²)

5F 3,300 m²

4F 3,300 m²

3F 3,300 m²

2F 1,650 m² (Aetina 660 m²)



**INNODISK
HEADQUARTER**

PRODUCTION

1,440K / Maximum Capacity (SMT x 8)

CERTIFICATIONS

ISO9001 / ISO14001 / ISO45001 /
QC080000 / ISO14064-1 /
ISO27001 / **IEC62443-4-1**

MANUFACTURING

New Taipei City / Yilan County



QUALITY & SUSTAINABILITY: OUR TOP PRIORITY

PARTNERSHIP AND AWARDS

Partner

Official Intel
Gold Partner

NVIDIA Elite Partner (Aetina)
MGX Partner (Aetina)

Qualcomm
IoT Partner

Official partner of
Azure Sphere

AI ASIC & NPU
Partner

Achievements

World's TOP 1

Industrial Grade SSD Provider

World's TOP 10

DRAM Module Provider

TOP 40 International
Taiwanese Brand

Asia's 200 Best Companies
Under A Billion

Innovation

2026 **E3.L PCIe Gen5 Data Center SSD**
2026 **LPDDR5X LPCAMM2**
2026 **MIPI over Type-C Camera Module**
2026 **Edge AI System** (APEX-P200)
2026 **AI Agent Edge Workstation** (AIP-FR68S)
2026 **Multi-Accelerator Edge AI System** (AIP-MURE)



2026 **High-speed LAN Module**
2025 **MIPI over Type-C Camera**
2025 **E3.L 5QS-P Data Center SSD**
2024 **E1.S 4TG2-P SSD**
2023 **nanoSSD**



2025 **CXL Memory Module**
2022 **Ultra Temp. DDR4 DRAM**



2024 **USB Camera Module**

MARKET TREND & PRODUCT STRATEGY

Cloud & Communication

1G to 5G → Cloud & AI

Bandwidth Growth / Ultra-Low Latency & Infrastructure / Cloud Service & AI Training

Large Language Model

Edge AI

-Privacy
-Latency
-Bandwidth

Edge Computing & Device

PLC → IPC → IIoT → AIoT

Automation / Industrial / Vertical / Connected

Open Sources SLM
Neural Network: CNN,RNN

Industry Edge AI

- Focus on OT-oriented
- Rugged & Robust
- Real Time 24hr/365days



Enterprise Edge AI

- Focus on IT-oriented
- Process Optimization & Scalability
- Information Security & Privacy



CLOUD AND EDGE AI DUAL-REVOLUTION

LEVEL UP APPLICATION

AI Infrastructure

- GPU Server / Networking Switch / Router
- Humanoid Robot / Drone / Autonomous



Global Vertical Leaders

- Medical / 5G / Surveillance / Gaming / Automation
- Tier-1 Market Leaders



High Value-added Industrial Solution Providers

- Manufacturing / Retail & Logistic / Smart Energy / Health Care / Communication / Aerospace / Entertainment / Enterprise
- High Value-added & Customization
- Longevity Support



EDGE AI STACK: ARCHITECT INTELLIGENT

Technology Stack for Edge Computing

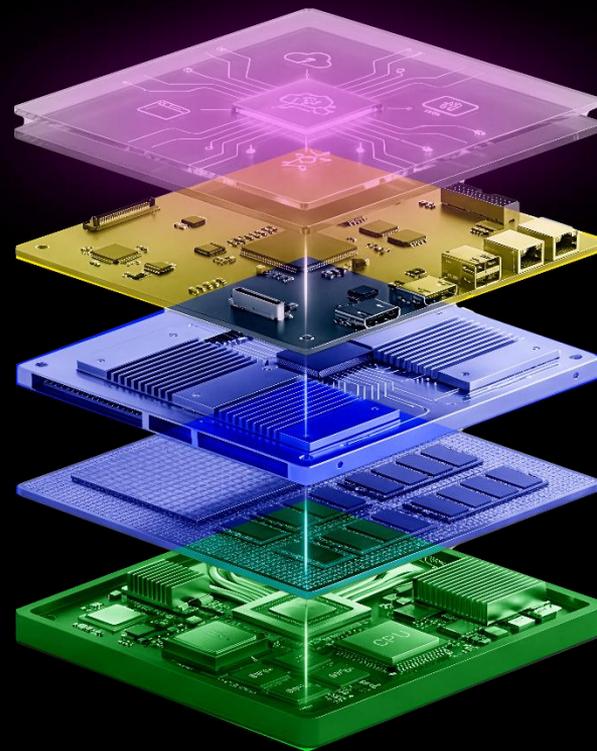
Stack 5: Software

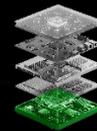
Stack 4: Sensing & Communication

Stack 3: Storage

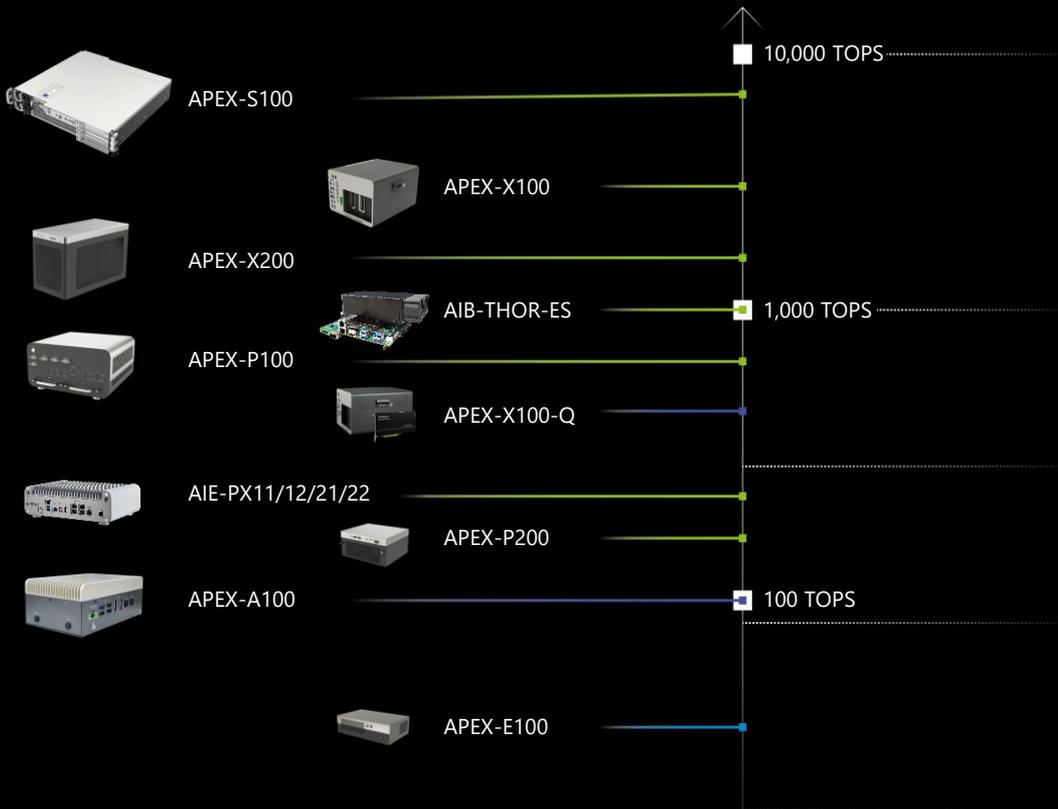
Stack 2: Memory

Stack 1: Compute

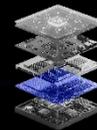




- NVIDIA
- Qualcomm
- Intel
- AI ASIC



(TOPS @ INT8)



EMPOWERING EDGE AI COMPUTING

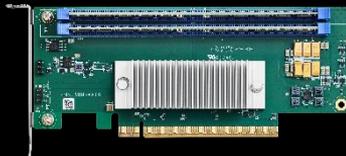
DDR5 7200MT/s

 Edge AI Ultra-High-Speed Computing Engine


- **Target:** Edge AI & high-speed networking bandwidth.
- **Performance:** Ultra-low latency & superior stability.
- **Application:** Real-time edge inference & massive data processing.

BREAKING AI ARCHITECTURE BOTTLENECKS

CXL AIC (ADD-IN-CARD)

 Breaking Edge Computing's Memory Barrier


- **Objective:** Overcoming the "Memory Wall" in next-gen AI.
- **Key Feature:** Seamless, large-scale memory scaling.
- **Benefit:** Optimized TCO for Hyperscale Data Centers & AI Training.

DRAM Module Portfolio

AI Memory



Embedded Memory



Server Memory



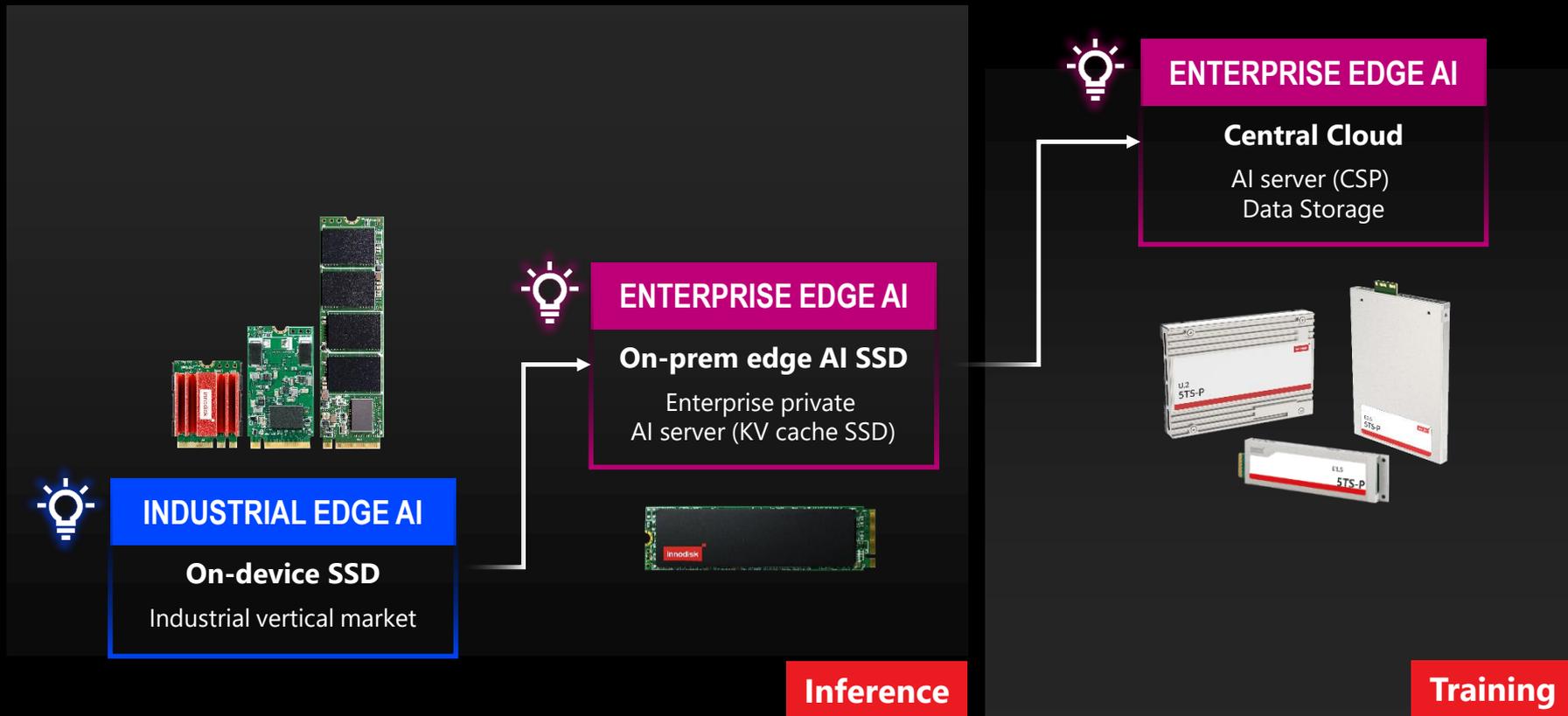
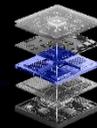
Wide Temp. Memory

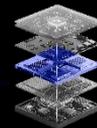


Customized Memory



- **Formfactor:** CMM2 / CUDIMM / CSODIMM / SODIMM / RDIMM / VLP /
- **Technology & Generation:** CXL / DDR5 / DDR4 / DDR3 / DDR2





MAXIMIZING SYSTEM BOOT RELIABILITY

DATACENTER SSD | BOOT DRIVE

SATA III and PCIe Gen 4 / U.2, M.2, 2.5", E1.S



- **Optimized Booting:** High-speed startup and OS loading.
- **Reliability:** High endurance for frequent write cycles.

ACCELERATING LARGE-SCALE DATA THROUGHPUT

DATACENTER SSD | STORAGE DRIVE

PCIe Gen5 / U.2, EDSFF (E3.S, E3.L and E1.S)



- **High Throughput:** Designed for large-scale data handling and sustained performance.
- **Low Latency:** Scalable for heavy processing and storage.

Flash Storage (SSD) Portfolio

PCIe



SD



SATA



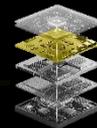
USB



PATA



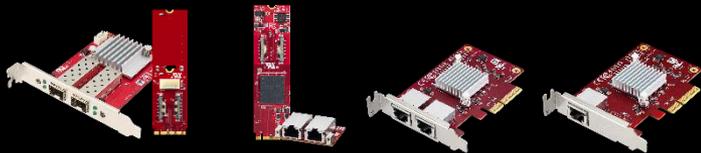
- **Formfactor & Technology:** M.2 / U.2 / CFexpress / EDSFF / 2.5" / 1.8" / SATA Slim / SATADOM / mSATA / CFast / nanoSSD / CompactFlash Card / SD Card & microSD Card / USB / USB EDC



REVOLUTIONIZING COMPACT SYSTEM BOOTING

HIGH SPEED LAN MODULE

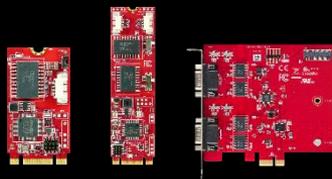
M.2 to Dual 10GbE SFP+ LAN Module
M.2 2280 Dual 10GbE LAN Module



- **Space-Efficient:** World's first M.2 SFP+ LAN module for compact builds.
- **Optimized Startup:** High-speed, stable transfers for accelerated boot times.

ENHANCING HIGH-EFFICIENCY DATA EXCHANGE

CAN FD SERIES



- **Rapid Communication:** Fast, reliable data exchange for complex systems.
- **Superior Capacity:** Higher data-per-message volume to boost efficiency.

Intelligent Peripheral Solution Portfolio

LAN



CAN Bus & CAN FD



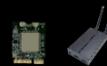
CAN + GNSS

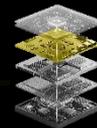


Serial



Wi-Fi





RUGGEDIZED LONG-RANGE VISION & CLARITY

GMSL2 CAMERA SERIES

High-bandwidth, long-range, and low-latency transmission

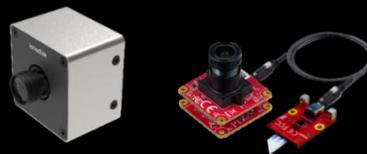


- **IP67/IP69K Ruggedized:** Maximum dust, water proof.
- **15m Long-Reach:** Stable performance over extended distances.
- **On-board ISP:** Superior image quality and professional control.
- **NVIDIA Jetson & RPi Ready:** Support for leading AI platforms.

REDEFINING EDGE AI VISION STANDARDS

MIPI OVER TYPE-C CAMERA MODULE

8MP Fixed Focus Camera Module



- **Award-Winning:** Patented technology & Taiwan Excellence recognized.
- **MIPI Extension:** High-speed signals optimized for Edge AI.
- **On-board ISP:** Integrated chip for superior image control.
- **Multi-Platform Ready:** Support for NVIDIA Jetson, Intel, and Raspberry Pi.

Camera Module Portfolio

USB 2.0



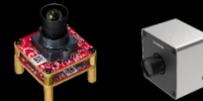
MIPI CSI-2



GMSL2

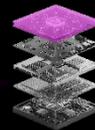


MIPI over Type-C



Capture Card





Accelerate Agentic AI Development



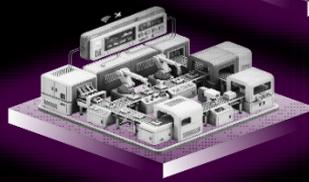
Model Training / Inference Tool Kits



API & SDK

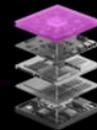


Remote Management

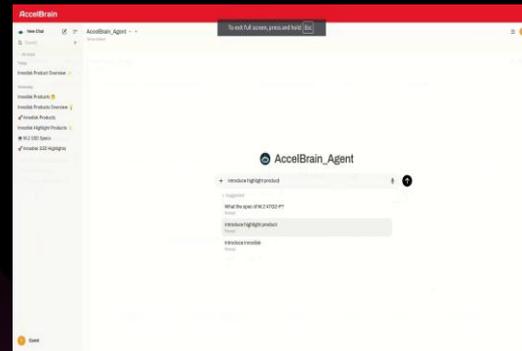
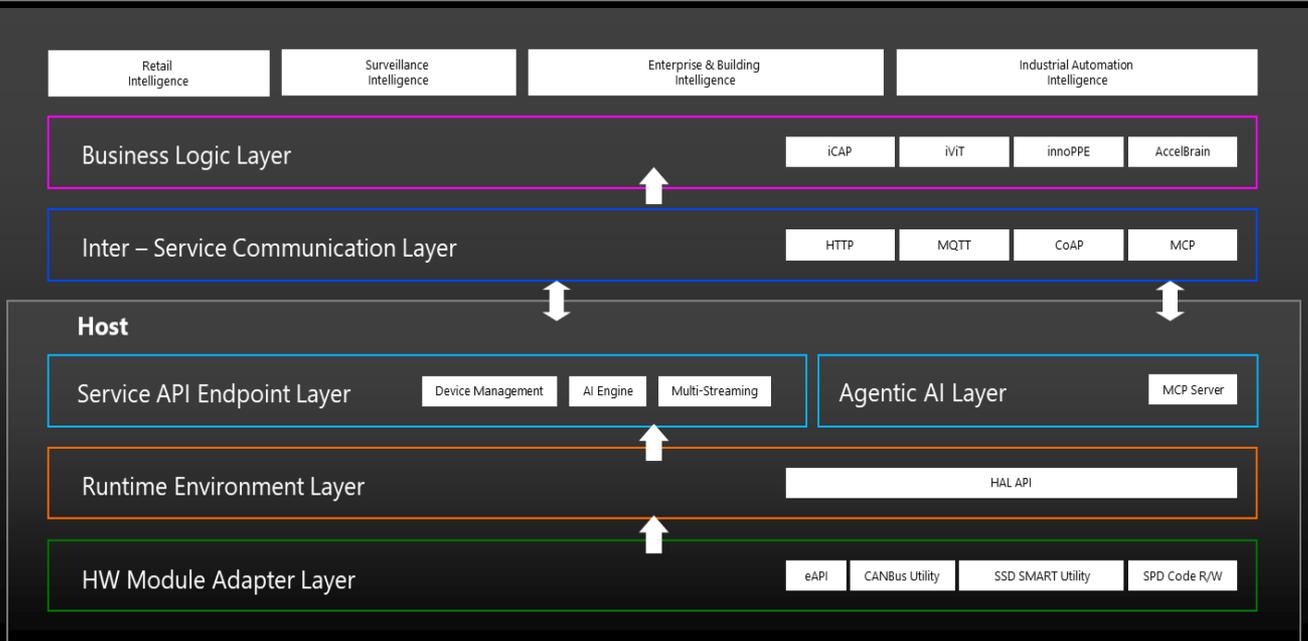


OS / Driver

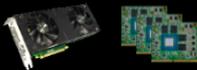
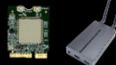




INNOVATING IN SOFTWARE. ELEVATING VALUE AT THE EDGE.



INNODISK EDGE AI BUILDING BLOCKS

SOFTWARE / FIRMWARE	Cloud AI Platform	iCAP Remote Management / OOB / OTA / Recovery / Security / Diagnosis									
	AI-Stack Tool / SDK	iVIT	AccelBrain	AccelTune	AccelBrain(RAG) / AccelTune / iVIT-Training / iVIT-Inference						
	Software Tools	iSMART / iTracker / iOPAL / iRAID									
	Operating System	x86 / Arm, Window / Linux									
AI ACCELERATOR	NVIDIA		Intel		Qualcomm		AI ASIC				
											
AI PLATFORM	x86						Arm				
	Atom_X7000	12 th Gen Core-i	13/14 th Gen Core-i	Core Ultra Series1	Core Ultra Series 2	Core Ultra Series 3	Xeon 6	NVIDIA Jetson	Qualcom	AMD Xilinx	NXP i.MX 8M Plus
EMBEDDED PERIPHERAL	Flash	DRAM	Display	Storage	LAN	CAN Bus / CAN FD	GNSS	Wireless			
											
SENSOR	Embedded Camera Module					Air & Gas Sensor					
											

AI IN ACTION GLOBAL CAMPAIGN

EMBEDDED WORLD 2026

@Nuremberg, Germany



NVIDIA GTC 2026

@San Jose, USA



INNODISK AI IN ACTION

Promote AI solutions with global partners



Smart City Expo World Congress



Edge Tech+ @Japan



Smart Factory & Automation @Korea



ICE 2026 @Spain

ESG COMMITMENT

2025 HIGHLIGHTS

- Maintaining a Corporate Governance Evaluation between **6% to 20%**.
- Approved by the Board of Directors, the company has set its Net Zero Emission Pathway, marking a proactive step toward long-term net-zero transition.
- Established the **“Sustainability Development & Information Security Committee”** to enhance ESG commitment.
- Received the EcoVadis Bronze Medal, CommonWealth Sustainability Awards, and the Parenting Family-Friendly Workplace Award, reflecting Innodisk’s well-rounded achievements in sustainability.



@WUWEIGANG WATERBIRD REFUGE, YILAN COUNTY

Ecological restoration / Habitat conservation / Windbreak afforestation / Community revitalization

2026 OBJECTIVES

- Accelerated renewable energy transition and energy management efforts, delivering concrete carbon reduction results.
- Empowered employees and communities through inclusion and biodiversity programs.
- Reinforced sustainability governance and transparency in line with international frameworks such as IFRS.



@GREEN BAY, NEW TAIPEI CITY

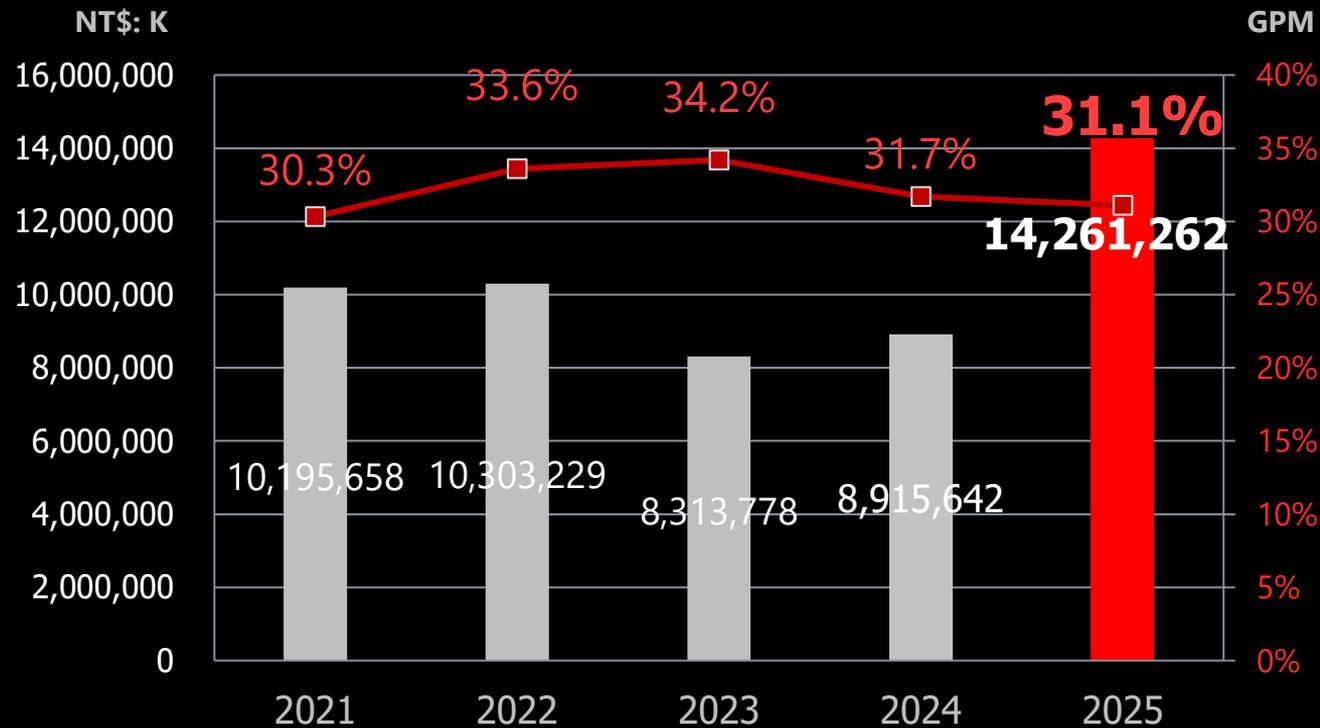
Marine conservation / Ocean education / Corporate family beach cleanups



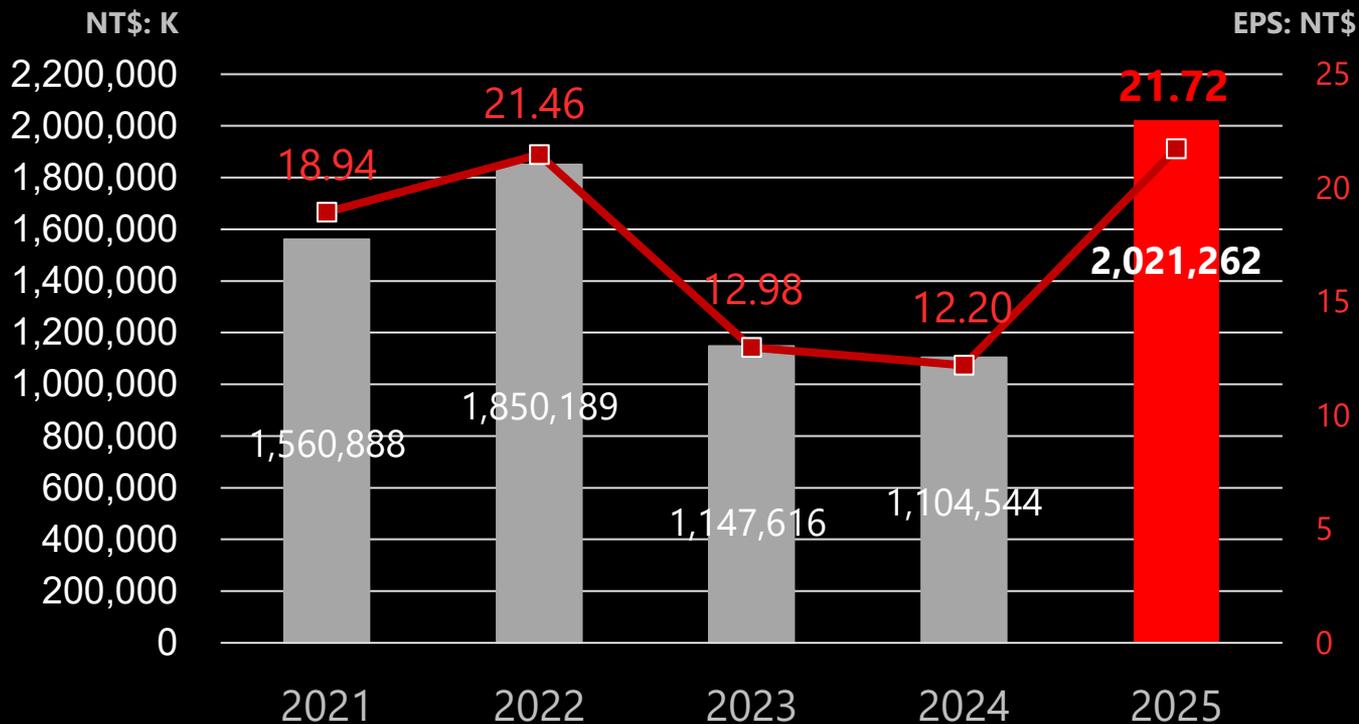
PATH TO SUSTAINABILITY

FINANCIAL INFORMATION

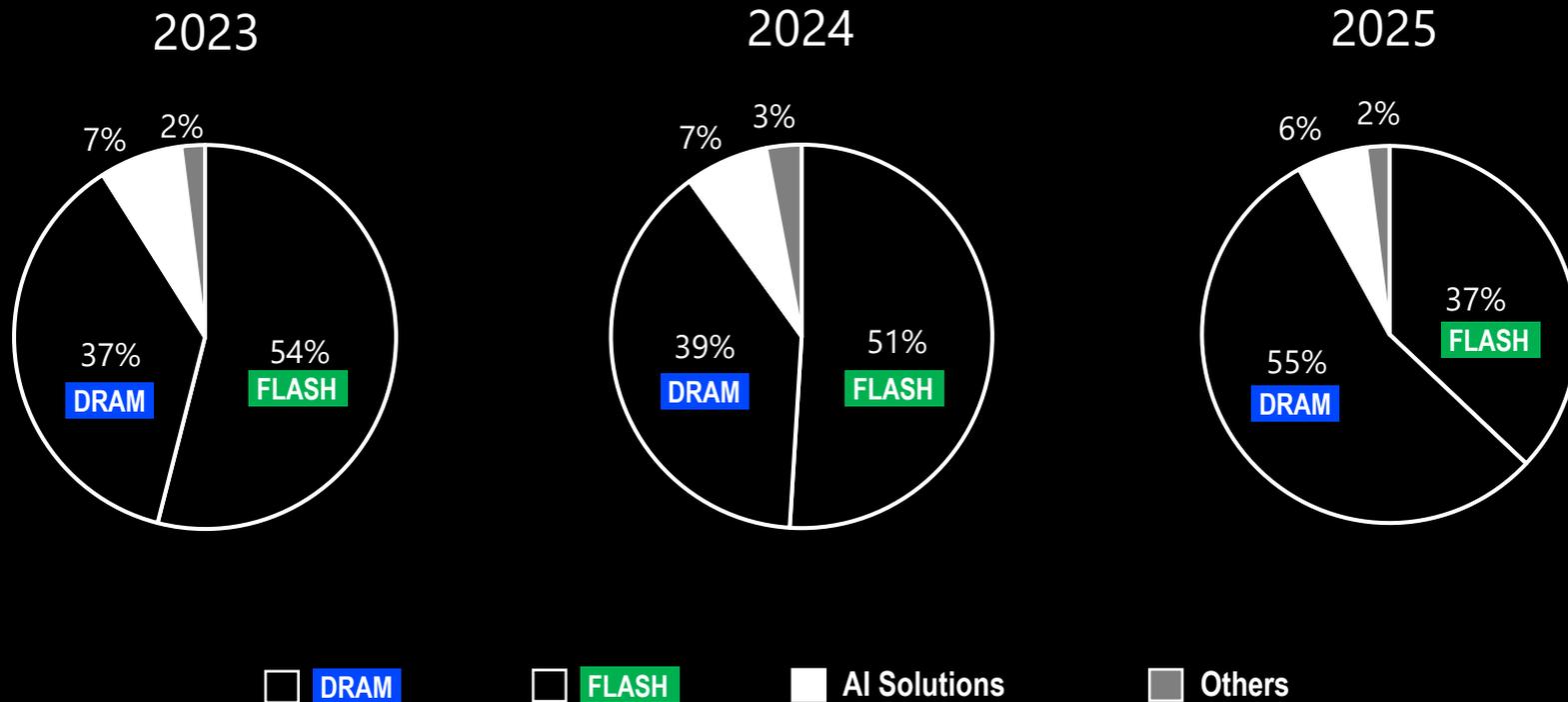
Revenues and GPM over last 5 years



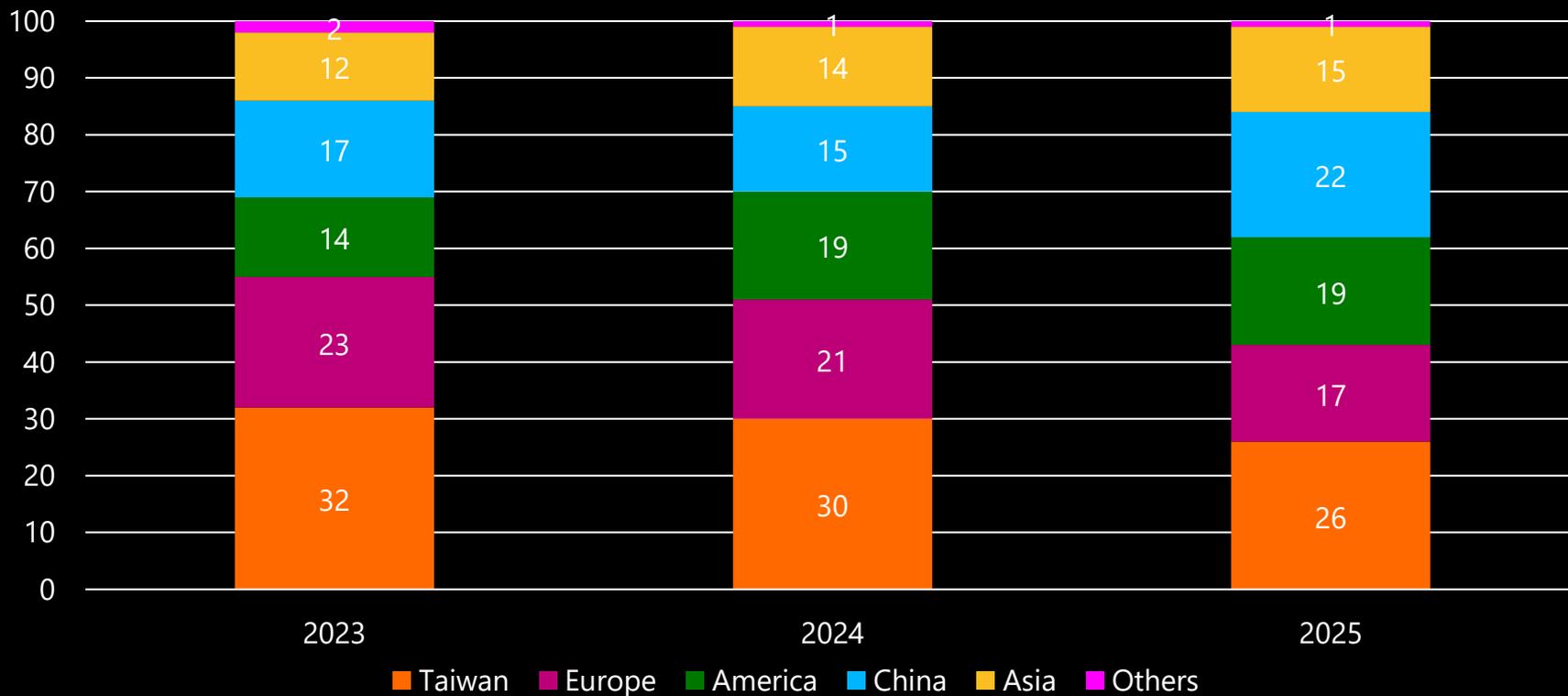
Net Profits and EPS over last 5 years



Revenue Breakdown by Product Lines



Revenue Breakdown by Regions



Annual Income Statement

	2023	2024	2025	YoY
Revenues	8,313,778	8,915,642	14,261,262	60.0%
Cost of good sold	5,467,866	6,090,393	9,829,334	61.4%
Gross profit	2,845,912	2,825,249	4,431,928	56.9%
Operation expenses	1,465,884	1,646,753	2,042,500	24.0%
Operation profits	1,380,028	1,178,496	2,389,428	102.8%
Non-operating income and expenses	51,060	170,643	67,884	-60.2%
Profit before tax	1,431,088	1,349,139	2,457,312	82.1%
Income tax expense	286,921	244,595	436,050	78.3%
Net profits	1,144,167	1,104,544	2,021,262	83.0%
Non-controlling interests	-3,449	-1,628	-14,381	
Net profit attributable to parent company	1,147,616	1,106,172	2,035,643	84.0%
EPS	12.98	12.20	21.72	
Gross margin	34.2%	31.7%	31.1%	
Operating margin	16.6%	13.2%	16.8%	
Net profit rate	13.8%	12.4%	14.2%	

Q&A

innodisk

**ARCHITECT
INTELLIGENCE**